SILICONE GAP FILLER TGF-BXS-SI

ultrasoft, flexible

HALA

TGF-BXS-SI is an electrically insulating thermally conductive silicone gap filler. It is ideal for use in applications where thermal transfer over large gaps caused e.g. by big tolerances or different stack up heights must be achieved. Due to the specific formulation and filling with ceramic particles the silicone elastomer has a good thermal conductivity. Through its ultra softness and flexibility the material perfectly mates to irregular surfaces thus filling gaps at minimum pressure. By its use the total thermal resistance is minimised. The natural tackiness of the material allows for an easy and reliable pre-assembly. The optional PSA on one side provides for a strong adhesiveness.

Release 02 / 2018

PROPERTIES

- Ultra soft and compliable
- Thermal conductivity: 1.2 W/mK
- Operates at minimum pressure
- Extraordinary chemical resistance and longterm stability
- Shock-absorbing
- Easy mounting through self tackiness
- Two-side tacky or one-side adhesive

AVAILABILITY

- Sheet 200 x 400 mm
- Tacky on both sides (TGF-BXSXXXX-SI)
- Tacky on one side, PSA adhesive on one side (TGF-BXSXXXX-SI-A1)
- Die cut parts
- Kiss cut parts on sheet

APPLICATION EXAMPLES

Thermal link of:

- SMD packages
- Through-hole vias
- Capacitors
- Electronic parts to heat pipes

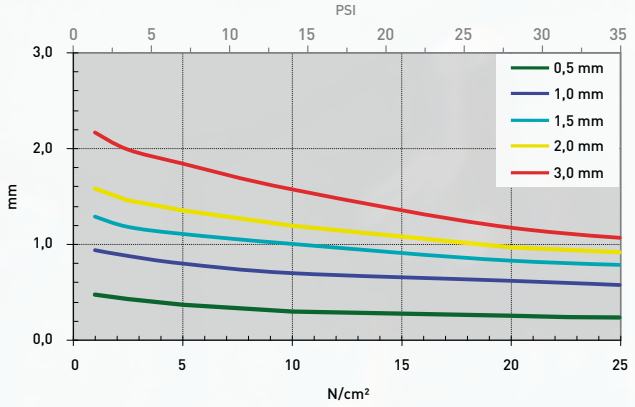
For use in Automotive applications / Laptops / Medicine engineering / Industrial PCs

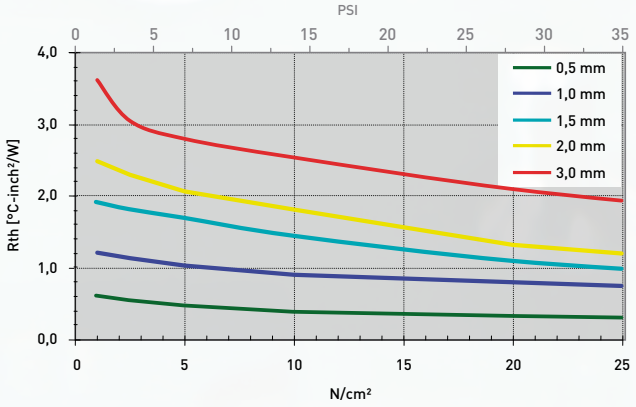
Property	Unit	TGF-BXS0500-SI	TGF-BXS1000-SI	TGF-BXS1500-SI	TGF-BXS2000-SI	TGF-BXS3000-SI
Material		Ceramic filled silicone	Ceramic filled silicone	Ceramic filled silicone	Ceramic filled silicone	Ceramic filled silicone
Colour		Pink	Pink	Pink	Pink	Pink
Thickness	mm	0.5	1.0	1.5	2.0	3.0
Hardness	Shore 00	15	15	15	15	15
Density	g/cm³	2.3	2.3	2.3	2.3	2.3
UL Flammability	UL 94	VO	VO	VO	VO	VO
RoHS Conformity	2011 / 65 / EU	Yes	Yes	Yes	Yes	Yes
Thermal						
Resistance[1] @ 35 PSI @ Thickness	°C-inch²/W (mm)	0.31 (0.24)	0.75 (0.58)	1.00 (0.80)	1.20 (0.92)	1.95 (1.09)
Resistance[1] @ 15 PSI @ Thickness	°C-inch²/W (mm)	0.39 (0.30)	0.90 (0.70)	1.45 (1.01)	1.81 (1.19)	2.54 (1.57)
Resistance[1] @ 7 PSI @ Thickness	°C-inch²/W (mm)	0.48 (0.37)	1.03 (0.80)	1.70 (1.11)	2.07 (1.35)	2.80 (1.84)
Thermal Conductivity	W/mK	1.2	1.2	1.2	1.2	1.2
Operating Temperature Range	°C	- 40 to + 150	- 40 to + 150	- 40 to + 150	- 40 to + 150	-40 to + 150
Electric						
Dielectric Strength	kV / mm	> 6.5	> 6.5	> 6.5	> 6.5	> 6.5
Volume Resistivity	Ohm - cm	3.5×10^{12}	3.5×10^{12}	3.5×10^{12}	3.5×10^{12}	3.5×10^{12}
Dielectric Constant	@ 1 MHz	3.87	3.87	3.87	3.87	3.87

Measurement technique according to: [1]ASTM D 5470. All data without warranty and subject to change. Please contact us for further data and information.

Thicknesses: 0.5 mm / 1.0 mm / 1.5 mm / 2.0 mm / 2.5 mm / 3.0 mm / 3.5 mm / 4.0 mm / 4.5 mm / 5.0 mm / .. 12.0 mm

mm vs. N/cm² (PSI) / Rth vs. N/cm² (PSI)





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